

Heigl Technologies

Hot Melt: Low Temp Case Sealing



Heigl Technologies would like to introduce our HAS-HM130 hot melt. The HAS-HM130 is a low temp fast setting hot melt for packaging operations. HAS-HM130 is applied at a lower temperature which eliminates burning and charring. It exhibits excellent bonds on a wide variety of board and paper stocks. It has excellent heat stability and low viscosity for good machining on all standard hot melt application equipment. It exhibits aggressive tack, which is important where short compression sections are encountered.

HAS-HM130 Technical Data

Application: Low Temp Case Sealing / Tray Forming

VISCOSITY: 2000 cps @ 225 F
900 cps @ 250 F
625 cps @ 275 F
525 cps @ 300 F
300 cps @ 325 F

Softening Point: 169 F

Form: Slats / Chicklet Form

Color: Opaque Yellow

Solids: 100%

For cost savings information give us a call!!!!

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